

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address COMMISSIONER FOR PATENTS F O Box 1450 Alexandria, Virginia 22313-1450 www.uspilo.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
09/782,169	02/14/2001	Shoji Hara	010164	2107	
38834 7590 07/08/2008 WESTERMAN, HATTORI, DANIELS & ADRIAN, LLP			EXAM	EXAMINER	
1250 CONNECTICUT AVENUE, NW		TALBOT, BRIAN K			
	SUITE 700 WASHINGTON, DC 20036		ART UNIT	PAPER NUMBER	
		1792			
			MAIL DATE 07/08/2008	DELIVERY MODE PAPER	

# Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.



Commissioner for Patents United States Patent and Trademark Office P.O. Box 1450 Alexandria, VA 22313-1450 www.usplo.gov

# BEFORE THE BOARD OF PATENT APPEALS AND INTERFERENCES

Application Number: 09/782,169 Filing Date: February 14, 2001 Appellant(s): HARA ET AL.

> Stephen Adrian For Appellant

EXAMINER'S ANSWER

 This is in response to the appeal brief filed April 9, 2008 appealing from the Office action mailed February 15, 2007. Art Unit: 1792

## (1) Real Party in Interest

A statement identifying by name the real party in interest is contained in the brief.

# (2) Related Appeals and Interferences

The examiner is not aware of any related appeals, interferences, or judicial proceedings which will directly affect or be directly affected by or have a bearing on the Board's decision in the pending appeal.

#### (3) Status of Claims

The statement of the status of claims contained in the brief is correct.

## (4) Status of Amendments After Final

No amendment after final has been filed.

# (5) Summary of Claimed Subject Matter

The summary of claimed subject matter contained in the brief is correct.

#### (6) Grounds of Rejection to be Reviewed on Appeal

The appellant's statement of the grounds of rejection to be reviewed on appeal is correct.

It is noted that Affidavits were filed and considered, however, the rejection was maintained by the Examiner. In is noted that the Affidavits were not specifically referred to in the arguments contained in the Appeal Brief.

### (7) Claims Appendix

The copy of the appealed claims contained in the Appendix to the brief is correct.

#### (8) Evidence Relied Upon

JP 54-066966 A Oizumi et al. 5-1979

Art Unit: 1792

JP 62-060640	Kuromaru et al.	3-1987
JP 11-240106	Yamaguchi	9-1999
5,156,710	Chen et al.	10-1992
5,741,598	Shiotani et al.	4-1998
5,681,443	Ameen et al.	10-1997

## (9) Grounds of Rejection

The following ground(s) of rejection are applicable to the appealed claims:

# Claim Rejections - 35 USC § 103

Claims 1-9, 13 and 17-20 are rejected under 35 U.S.C. 103(a) as being unpatentable over Chen et al. (5,156,710) or Shiotani et al. (5,741,598) in combination with JP 54-066966.

Chen et al. (5,156,710) or Shiotani et al. (5,741,598) teach applying a metal layer to a polyimide layer and heating to form a conductor layer atop the polyimide layer. The polyimide layer is formed by imidizing a polyamic acid. The metal layer can be applied by a variety of ways but laminating a metal foil is most preferred.

Shiotani et al. (5,741,598) further teach that it is conventional in the art to form the metal layer atop the polyimide film by plating (col. 1, lines 27-30.) The laminate is formed by applying the metal layer to the imide layer and heating by pressure.

Chen et al. (5,156,710) or Shiotani et al. (5,741,598) fail to teach heating the said laminate.

Art Unit: 1792

JP 54-066966 teaches manufacturing a composite sheet. A metal foil and a heat-resistant polymer are combined to form a laminate and then the laminate is aged at a temperature and atmosphere that does not result in reduced adhesion strength (abstract).

Therefore, it would have been obvious for one skilled in the art at the time the invention was made to have modified the Chen et al. (5,156,710) or Shiotani et al. (5,741,598) process by performing a subsequent ageing step as evidenced by JP 54-066966 with the expectation of achieving a superior bond between the polyimide and the metal layers.

Claims 1, 3-11,13 and 17-20 are rejected under 35 U.S.C. 103(a) as being unpatentable over JP 62-60640 or JP 11-240,106 in combination with JP 54-066966.

JP 62-60640 teaches sputtering or vapor depositing a metal atop a thermoplastic polyimide sheet and heating to form the laminated film. JP 62-60640 forms the laminates in a continuously mode of extrusion forming. Not laminated with metal, the resin may be plated with metal through chemical plating, electroplating, sputtering or vapor deposition to produce the laminates of the invention (pg. 7 of translation filed 1/09/04)

JP 11-240,106 teaches applying a metal or metal oxide layer on a polyimide layer by vapor deposition or sputtering (abstract).

JP 62-60640 or JP 11-240,106 fails to teach heating the said laminate.

JP 54-066966 teaches manufacturing a composite sheet. A metal foil and a heat-resistant polymer are combined to form a laminate and then the laminate is aged at a temperature and atmosphere that does not result in reduced adhesion strength (abstract).

Art Unit: 1792

Therefore, it would have been obvious for one skilled in the art at the time the invention was made to have modified the JP 62-60640 or JP 11-240,106 process by performing a subsequent ageing step as evidenced by JP 54-066966 with the expectation of achieving a superior bond between the polyimide and the metal layers.

With respect to claims 19 and 20 that recite a peel strength, it is the Examiner's position that the claimed peel strength would be achieved by the combination of prior art as the processes and materials are similar.

With respect to claims 8 and 9, the claims recite a using pressure with the heating step.

While the Examiner acknowledges the fact that the prior art fails to teach pressure in the subsequent heating step, the prior art does teach utilizing pressure in forming the laminate that improves adhesion between the polyimide and the metal layer. Hence, it is the Examiner's position that one skilled in the art would have had a reasonable expectation of achieving similar success, i.e. improved adhesion, with the aid of pressure in the subsequent heating step as evidenced by the heating/pressure step in forming the laminate.

Claim 12 is rejected under 35 U.S.C. 103(a) as being unpatentable over JP 62-60640, Chen et al. (5,156,710), Shiotani et al. (5,741,598) or JP 11-240,106 in combination with JP 54-066966 further in combination Ameen et al. (5,681,443).

JP 62-60640, Chen et al. (5,156,710), Shiotani et al. (5,741,598) or JP 11-240,106 in combination with JP 54-066966 fail to teach wet coating a metal atop the dry coated metal.

Ameen et al. (5,681,443) teaches forming printed circuits whereby a metal flash layer is applied to a polymer substrate by vapor deposition or sputtering and subsequently a metal layer is applied to the flash metal by electrodeposition.

Therefore, it would have been within the skill of one practicing in the art to have modified JP 62-60640, Chen et al. (5,156,710), Shiotani et al. (5,741,598) or JP 11-240,106 in combination with JP 54-066966 by forming a second metal coating by wet plating as evidenced by Ameen et al. (5,681,443) with the expectation of achieving success, i.e. a thicker coating.

## (10) Response to Argument

As no definition of a "laminate" is found in the specification, the Examiner has interpreted the term "laminate" to be "a uniting of two surfaces".

Appellant argued that the prior art teaches applying a metal foil on a polyimide film and that this does not constitute a laminate, and hence, the heat pressing step would not meet the claimed heating step.

As detailed in a previous Office Action, the Examiner has taken the position that upon heat pressing the metal foil and the polyimide film at one point, a laminate would be formed and the heat pressing would continue and constitute the claimed heating step. A laminate is formed when two layers are united, and this would occur throughout the heat pressing step. One skilled in the art would not stop the heat pressing step once this "uniting occurs". The heat pressing would continue, and therefore, an increase in adhesion would be produced sequentially with the heat pressing step. It has been well settled that generally, no invention is involved in the broad

Art Unit: 1792

concept of performing simultaneously operations which have previously been performed in sequence. *In re Tatincloux*. 108 USPO 125.

Appellant argued that the prior art teaches forming a metal film on the polyimide film but that it also does not constitute a laminate.

The Examiner disagrees. The prior art teaches forming the metal layer atop the polyimide film by a variety of dry plating processes including sputtering, chemical plating, vapor deposition. This is the same or similar process as claimed in claims 10 and 11. Hence, the Examiner has taken the position that the process would produce a laminate as is done in the prior art process. The subsequent heating step is taught by JP 54-066966.

Appellant argued that the prior art (JP 54-066966) teaches a ripening step which decreases the adhesion strength and not enhancing as claimed.

While the Examiner acknowledges the fact that JP 54-066966 teaches a decrease in adhesion with a ripening step, the JP 54-066966 reference also teaches the ripening step performed in an inert atmosphere to prevent this reduction of adhesion. Furthermore, since the claims do not recite a "particular amount" of enhanced adhesion, this limitation would be met by a microscopically small amount. It is the Examiner's position that while the JP 54-066966 does not recite a "positive" amount of increased adhesion, the fact that the heating step was found to negate the decrease in adhesion would provide support for no adhesion loss and/or a small increase.

Art Unit: 1792

Appellant argued that the prior art (JP 54-066966) teaches forming a polyimide layer on a

The claims are not commensurate in scope with the argument. The claims as written are

Page 8

metal layer and not a metal layer on a polyimide layer.

1

not limited as forming a metal layer on a polyimide layer. The claims recite "forming a

conductor layer directly adhering to one surface of a polyimide film". All the claims require is

forming a metal layer and a polyimide layer that are directly adhered to one another. Presuming

the claims are limited as argued by Appellant, the Examiner has taken the position that one

skilled in the art would have had a reasonable expectation of a success regardless of whether the

metal layer is applied to the polyimide layer or vice versa. Each way would constitute a metal

layer "directly adhering" to a polyimide layer.

(11) Related Proceeding(s) Appendix

No decision rendered by a court or the Board is identified by the examiner in the Related

Appeals and Interferences section of this examiner's answer.

For the above reasons, it is believed that the rejections should be sustained.

Respectfully submitted,

/Brian K Talbot/

Brian K. Talbot

Primary Examiner, Art Unit 1792

Art Unit: 1792

Conferees:

/Kathryn Gorgos/

Kathryn Gorgos

Appeals Specialist, TC 1700

/Timothy H Meeks/

Supervisory Patent Examiner, Art Unit 1792